

■ General Description

The AME5258 is a high efficiency monolithic synchronous buck regulator using a constant frequency, current mode architecture. The device is available in an adjustable version and fixed output voltages of 1.2V, 1.8V, 2.5V and 3.3V. Supply current with no load is 300µA and drops to <1µA in shutdown. The 2.5V to 5.5V input voltage range makes the AME5258 ideally suited for single Li-lon battery-powered applications. 100% duty cycle provides low dropout operation, extending battery life in portable systems. PWM pulse skipping mode operation provides very low output ripple voltage for noise sensitive applications. At very light load, the AME5258 will automatically skip pulses in pulse skip mode operation to maintain output regulation.

The AME5258 is simple to use. As with standard LDO's, Input and output capacitor are required. The only other element is a small, low cost, 2.2µH inductor.Low output voltages are easily supported with the 0.6V feedback reference voltage. And 100% duty cycle when Vin approaches Vout.

■ Features

- High Efficiency: Up to 96%
- 600mA Output Current at V_{IN}=3V
- 2.5V to 5.5V Input Voltage Range
- 1.5MHz Constant Frequency Operation
- No Schottky Diode Required
- Low Dropout Operation: 100% Duty Cycle
- 0.6V Reference Allows Low Output Voltages
- Shutdown Mode Draws<1μA Supply Current
- Current Mode Operation for Excellent Line and Load Transient Response
- Overtemperature Protection
- Internal Soft Start
- Space Saving 5-Pin SOT-25 Package
- Meet RoHS Standards

Applications

- Cellular Phones
- **Digital Cameras**
- Portable Electronics
- **USB Devices**
- MP3 Players
- LDO Replacement

■ Typical Application

Fixed Output Voltage

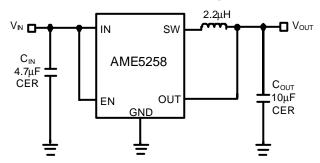
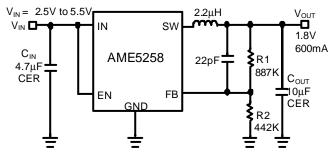


Figure 1: High Efficiency Step-Down Conventer

Adjustable Output Voltage



 $V_{OUT}=V_{FB} (R1+R2)/R2$

Figure 2: 1.8V at 600mA Step-Down Regulator



■ Function Diagram

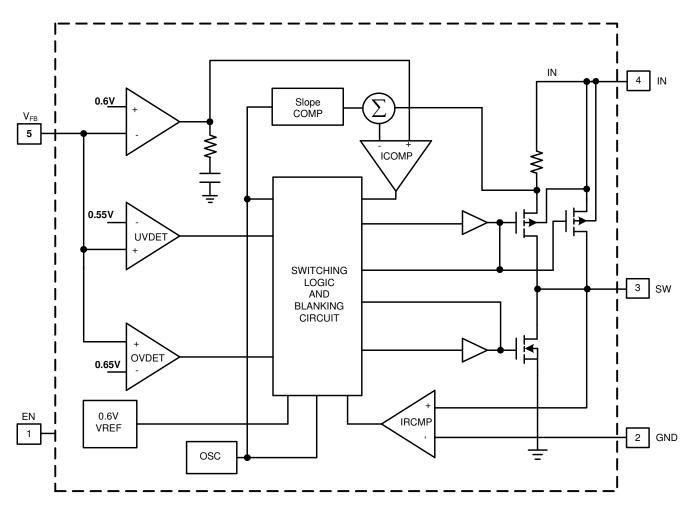
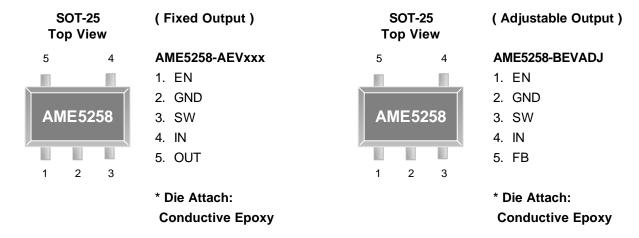


Figure 3: Founction Block Diagram



■ Pin Configuration

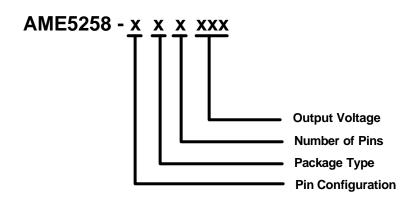


■ Pin Description

| Pin No | umber | Pin Name | Din Description |
|----------------|----------------|----------|---|
| AME5258-AEVxxx | AME5258-BEVADJ | Pin Name | Pin Description |
| 1 | 1 | EN | Enable Control Input. Forcing this pin above 1.5V enables the part. Forcing this pin below 0.3V shuts down the device. In shutdown, all functions are disabled drawing <1μA supply current. Do not leave EN floating. |
| 2 | 2 | GND | Ground Pin |
| 3 | 3 | sw | Switch Node Connection to Inductor. This pin connects to the drains of the internal main and synchronous power MOSFET switches. |
| 4 | 4 | IN | Main Supply Pin. Must be closely decoupled to GND, Pin2, with a 4.7μF or greater ceramic capactior. |
| N/A | 5 | FB | Feedback Pin. Receives the feedback voltage from an external resistive divider across the output. |
| 5 | N/A | OUT | Output Voltage for fixed version |



■ Ordering Information



| Pin Configuration | Package Type | Number of Pins | Output Voltage |
|---|-----------------|-------------------|--|
| A 1. EN (SOT-25) 2. GND 3. SW 4. IN 5. OUT | E: SOT-2X | V: 5 | 120: 1.2V 180: 1.8V 250: 2.5V 330: 3.3V |
| B 1. EN (SOT-25) 2. GND 3. SW 4. IN 5. FB | E: SOT-2X | V: 5 | ADJ: Adjustable |



■ Available Options

| Part Number | Marking* | Output Voltage | Package | Operating Ambient Temperature Range |
|----------------|----------|----------------|---------|-------------------------------------|
| AME5258-BEVADJ | BWMMXX | ADJ | SOT-25 | -40°C to +85°C |
| AME5258-AEV120 | BYRMXX | 1.2V | SOT-25 | -40°C to +85°C |
| AME5258-AEV180 | BYJMXX | 1.8V | SOT-25 | -40°C to +85°C |
| AME5258-AEV250 | BYNMXX | 2.5V | SOT-25 | -40°C to +85°C |
| AME5258-AEV330 | BYFMXX | 3.3V | SOT-25 | -40°C to +85°C |

Note

- 1. The first 3 places represent product code. It is assigned by AME such as BWM.
- 2. A bar on top of first letter represents Green Part such as BWM.
- 3. The last 3 places MXX represent Marking Code. It contains M as date code in "month", XX as LN code and that is for AME internal use only. Please refer to date code rule section for detail information.
- 4. Please consult AME sales office or authorized Rep./Distributor for the availability of output voltage and package type.

■ Absolute Maximum Ratings

| Parameter | Symbol | Maximum | Unit |
|--------------------------------------|------------------|--------------------------------|------|
| Input Supply Voltage | V _{IN} | 6 | V |
| EN, FB Voltages | V_{EN}, V_{FB} | V_{IN} | V |
| SW Voltage | V_{SW} | -0.3 to (V _{IN} +0.3) | V |
| P-Channel Switch Source Current (DC) | I _{SW} | 900 | mA |
| N-Channel Switch Sink Current (DC) | I _{SW} | 900 | mA |
| ESD Classification | | C* | |

Caution: Stress above the listed in absolute maximum ratings may cause permanent damage to the device.

^{*} HBM C: 4000V ~ 6000V



■ Recommended Operating Conditions

| Parameter | Symbol | Rating | Unit |
|----------------------------|------------------|-------------|------|
| Ambient Temperature Range | T _A | -40 to +85 | °C |
| Junction Temperature Range | TJ | -40 to +125 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | °C |

■ Thermal Information

| Parameter | Package | Die Attach | Symbol | Maximum | Unit |
|--|---------|------------------|-------------------|---------|--------|
| Thermal Resistance* (Junction to Case) | SOT-25 | | $\theta_{\sf JC}$ | 81 | °C / W |
| Thermal Resistance (Junction to Ambient) | SOT-25 | Conductive Epoxy | θ_{JA} | 260 | °C / W |
| Internal Power Dissipation | SOT-25 | | P_D | 400 | mW |
| Solder Iron (10 Sec)** | 350 | °C | | | |

^{*} Measure θ_{JC} on center of molding compound if IC has no tab.

^{**} MIL-STD-202G 210F

1.5MHz, 600mA Synchronous Buck Converter

AME5258

■ Electrical Specifications

 $\rm T_A \!\!=\!\! 25^{o}C.~V_{IN} \!\!=\!\! 3.6V$ unless otherwise specified.

| Parameter | Symbol | Test Condition | | Min | Тур | Max | Units |
|--------------------------------------|----------------------|--|---|--------|------|--------|-------|
| Input Volatge | V _{IN} | | | 2.5 | | 5.5 | V |
| Feedback Current | I _{FB} | | | | | ±30 | nΑ |
| Regulated Feedback Voltage | V _{FB} | AME52 | 58-BEVADJ | 0.5880 | 0.6 | 0.6120 | V |
| Reference Voltage Line Regulation | ΔV_{FB} | V _{IN} =2.5V to 5.5V | AME5258-BEVADJ | | 0.04 | 0.4 | %/V |
| | | V _{OUT} =1.2V, I _{OUT} =100mA | | 1.164 | 1.2 | 1.236 | |
| Regulated Output Voltage | ΔV _{OUT} | V _{OUT} =1.8V, I _{OUT} =100mA | | 1.746 | 1.8 | 1.854 | V |
| Regulated Output Voltage | AVOUT | V _{OUT} =2.5V, I _{OUT} =100mA | AME5258-AEVxxx | 2.425 | 2.5 | 2.575 | ľ |
| | | V _{OUT} =3.3V, I _{OUT} =100mA | | 3.201 | 3.3 | 3.399 | |
| Output Voltage Line Regulation | REG _{LINE} | V _{IN} =2.5V to 5.5V | | | 0.04 | 0.4 | %/V |
| Switch Current Limit | I _{CL} | V_{IN} =3V, V_{FB} =0.5V Duty Cycle < 35% | AME5258-BEVADJ | 0.75 | 1 | | A |
| CWIGH CUITOR EMILE | ICL. | V _{IN} =3V, V _{OUT} =90% Duty Cycle < 35% | AME5258-AEVxxx | 0.70 | ' | | |
| Output Voltage Load Regulation | V _{LOADREG} | | | | 0.5 | | % |
| Shutdown Current | I _{SD} | V _{EN} =0\ | /, V _{IN} =4.2V | | 0.1 | 1 | |
| Quiescent Current | IQ | | or V _{OUT} =90% V _{IN} =4.2V | | 300 | 450 | μА |
| Occillator Francisco | | V _{IN} =2.5V | & I _{OUT} =100mA | 1.2 | 1.5 | 1.8 | MHz |
| Oscillator Frequency | fosc | V _{FB} =0V | or V _{OUT} =0V | | 210 | | kHz |
| R _{DSON} of P-Channel FET | R _{DSON(P)} | l _{SW} =100mA | | | 0.4 | 0.6 | Ω |
| R _{DSON} of N-Channel FET | R _{DSON(N)} | I _{SW} = -100mA | | | 0.35 | 0.5 | Ω |
| Switch Leakage Current | I _{SW} | V_{EN} =0V, V_{SW} =0V or 5V, V_{IN} =5V | | | | ±1 | μА |
| EN Input Threshold (High) | V _{EH} | | | 1.5 | | | ,,, |
| EN Input Threshold (Low) | V _{EL} | | | | | 0.3 | V |
| EN Input Current | I _{EN} | | | | | ±1 | μА |



■ Detailed Description

Main Control Loop

The AME5258 uses a constant frequency, current modestep-down architecture. Both the main (P-channel MOSFET) and synchronous (N-channel MOSFET) switches are internal. During normal operation, the internal top power MOSFET is turned on each cycle when the oscillator sets the RS latch, and turned off when the current comparator, ICOMP, resets the RS latch. The peak inductor current at which ICOMP resets the RS latch, is controlled by the output of error amplifier EA. When the load current increases, it causes a slight decrease in the feedback voltage, FB, relative to the 0.6V reference, which in turn, causes the EA amplifier's output voltage to increase until the average inductor current matches the new load current. While the top MOSFET is off, the bottom MOSFET is turned on until either the inductor current starts to reverse, as indicated by the current reversal comparator IRCMP, or the beginning of the next clock cycle. The comparator OVDET guards against transient overshoots >7.8% by turning the main switch off and keeping it off until the fault is removed.

Pulse Skipping Mode Operation

At light loads, the inductor current may reach zero or reverse on each pulse. The bottom MOSFET is turned off by the current reversal comparator, IRCMP, and the switch voltage will ring. This is discontinuous mode operation, and is normal behavior for the switching regulator.

Short-Circuit Protection

When the output is shorted to ground, the frequency of the oscillator is reduced to about 210kHz, 1/7 the nominal frequency. This frequency foldback ensures that the inductor current has more time to decay, thereby preventing runaway. The oscillator's frequency will progressively increase to 1.5MHz when V_{FB} or V_{OUT} rises above 0V.

Dropout Operation

As the input supply voltage decreases to a value approaching the output voltage, the duty cycle increases toward the maximum on-time. Further reduction of the supply voltage forces the main switch to remain on for more than one cycle until it reaches 100% duty cycle. The output voltage will then be determined by the input voltage minus the voltage drop across the P-channel MOSFET and the inductor. An important detail to remember is that at low input supply voltages, the RDS(ON) of the P-channel switch increases (see Typical Performance Characteristics). Therefore, the user should calculate the power dissipation when the AME5258 is used at 100% duty cycle with low input Voltage.

Application Information

Inductor Selection

For most applications, the value of the inductor will fall in the range of 1 μ H to 4.7 μ H. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V_{IN} or V_{OUT}also increases the ripple current as shown in equation 1. A reasonable starting point for setting ripple current is IL = 240mA (40% of 600mA).

$$\mathbf{D}I_{L} = \frac{1}{f \times L} \times V_{OUT} \left(1 - \frac{V_{OUT}}{V_{IN}} \right)$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 720mA rated inductor should be enough for most applications (600mA+120mA). For better efficiency, choose a low DC-resistance inductor.



Inductor Core Selection

Once the value for L is known, the type of inductor must be selected. High efficiency converters generally cannot afford the core loss found in low cost powdered iron cores, forcing the use of more expensive ferrite or mollypermalloy cores. Actual core loss is independent of core size for a fixed inductor value but it is very dependent on the inductance selected. As the inductance increases, core losses decrease. Unfortunately, increased inductance requires more turns of wire and therefore copper losses will increase. Ferrite designs have very low core losses and are preferred at high switching frequencies, so design goals can concentrate on copper loss and preventing saturation. Ferrite core material saturates "hard", which means that inductance collapses abruptly when the peak design current is exceeded. This result in an abrupt increase in inductor ripple current and consequent output voltage ripple. Do not allow the core to saturate! Different core materials and shapes will change the size/current and price/current relationship of an inductor. Toroid or shielded pot cores in ferrite or permallov materials are small and don't radiate energy but generally cost more than powdered iron core inductors with similar characteristics. The choice of which style inductor to use mainly depends on the price vs. size requirements and any radiated field/EMI requirements.

CIN and COUT Selection

The input capacitance, CIN, is needed to filter the trapezoidal current at the source of the top MOSFET. To prevent large ripple voltage, a low ESR input capacitor sized for the maximum RMS current should be used.RMS current is given by:

$$I_{RMS} = I_{OUT} (max) \times \frac{V_{OUT}}{V_{IN}} \times \sqrt{\frac{V_{IN}}{V_{OUT}}} - 1$$

This formula has a maximum at $V_{IN} = 2V_{OUT}$, where $I_{RMS} = I_{OUT}/2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that ripple current ratings from capacitor manufacturers are often based on only 2000 hours of life which makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required.

Several capacitors may also be paralleled to meet size or height requirements in the design. The selection of COUT is determined by the effective series resistance (ESR) that is required to minimize voltage ripple and load step transients, as well as the amount of bulk capacitance that is necessary to ensure that the control loop is stable. Loop stability can be checked by viewing the load transient response as described in a later section.

The output ripple, V_{OUT} , is determined by :

$$\mathbf{D}V_{OUT} \mathbf{£} \mathbf{D}I_{L} \mathbf{\acute{e}} = SR + \frac{1}{8f \times C_{OUT}} \mathbf{\acute{u}} \mathbf{\acute{u}}$$

The output ripple is highest at maximum input voltage since IL increases with input voltage. Multiple capacitors placed in parallel may be needed to meet the ESR and RMS current handling requirements. Dry tantalum, special polymer, aluminum electrolytic and ceramic capacitors are all available in surface mount packages. Special polymer capacitors offer very low ESR but have lower capacitance density than other types. Tantalum capacitors have the highest capacitance density but it is important to only use types that have been surge tested for use in switching power supplies. Aluminum electrolytic capacitors have significantly higher ESR but can be used in cost-sensitive applications provided that consideration is given to ripple current ratings and long term reliability. Ceramic capacitors have excellent low ESR characteristics but can have a high voltage coefficient and audible piezoelectric effects. The high Q of ceramic capacitors with trace inductance can also lead to significant ringing

Using Ceramic Input and Output Capacitors

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. However, care must be taken when these capacitors are used at the input and output. When a ceramic capacitor is used at the input and the power is supplied by a wall adapter through long wires, a load step at the output can induce ringing at the input, V_{IN} . At best, this ringing can couple to the output and be mistaken as loop instability. At worst, a sudden inrush of current through the long wires can potentially cause a voltage spike at V_{IN} large enough to damage the part.



Output Voltage Programming

The output voltage is set by an external resistive divider according to the following equation:

$$V_{OUT} = V_{REF} \times (1 + \frac{R_2}{R_1})$$

Where VREF equals to 0.6V typical. The resistive divider allows the FB pin to sense a fraction of the output voltage as shown in Figure 4.

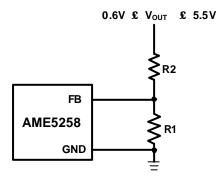


Figure 4: Setting the AME5258 Output Voltage

Thermal Considerations

In most applications the AME5258 does not dissipate much heat due to its high efficiency. But, in applications where the AME5258 is running at high ambient temperature with low supply voltage and high duty cycles, such as in dropout, the heat dissipated may exceed the maximum junction temperature of the part. If the junction temperature reaches approximately 160°C, both power switches will be turned off and the SW node will become high impedance. To avoid the AME5258 from exceeding the maximum junction temperature, the user will need to do some thermal analysis. The goal of the thermal analysis is to determine whether the power dissipated exceeds the maximum junction temperature of the part. The temperature rise is given by:

$$T_R = (PD)(q_{IA})$$

Where PD is the power dissipated by the regulator and θ_{JA} is the thermal resistance from the junction of the die to the ambient temperature.

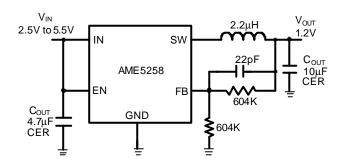


Figure 5: 1.2V Step-Down Regulator

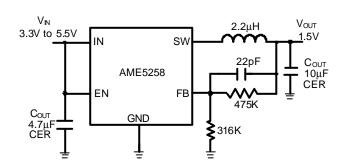


Figure 6: 1.5V Step-Down Regulator

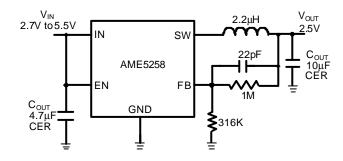
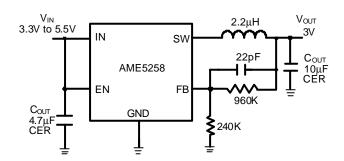


Figure 7: 2.5V Step-Down Regulator



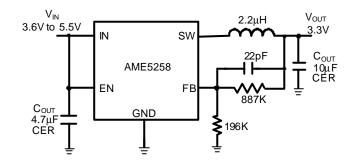


Figure 8: 3V Step-Down Regulator

Figure 9: 3.3V Step-Down Regulator

PC Board Layout Checklist

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the AME5258. These items are also illustrated graphically in Figures 10 and Figures 11. Check the following in your layout:

- 1. The power traces, consisting of the GND trace, the SW trace and the V_{IN} trace should be kept short, direct and wide.
- 2. Does the V_{FB} pin connect directly to the feedback resistors? The resistive divider R1/R2 must be connected between the (+) plate of C_{OUT} and ground.
- 3. Does the (+) plate of CIN connect to V_{IN} as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
- 4. Keep the switching node, SW, away from the sensitive V_{FB} node.
- 5. Keep the (-) plates of $C_{\rm IN}$ and $C_{\rm OUT}$ as close as possible.

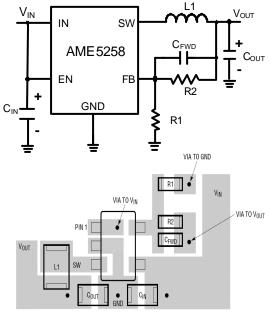
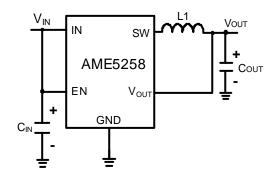


Figure 10: AME5258 Adjustable Voltage Regulator Layout Diagram



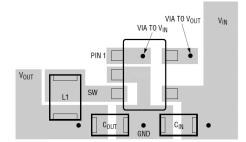
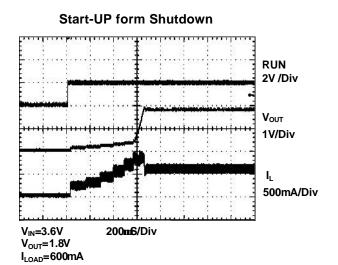
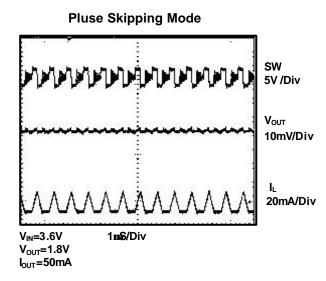
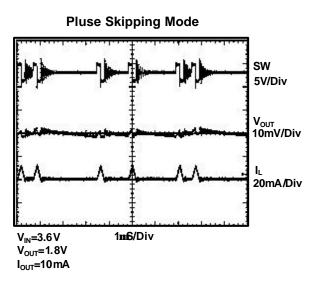


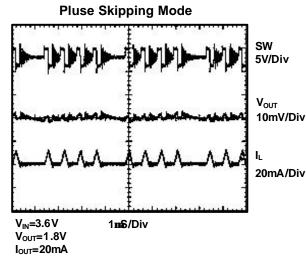
Figure 11: AME5258 Fixed Voltage Regulator Layout Diagram

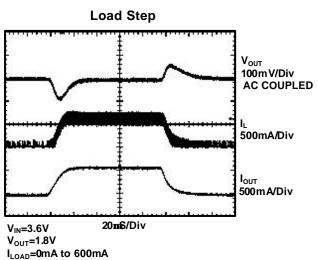


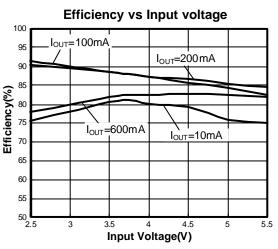






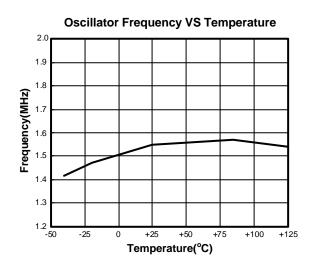


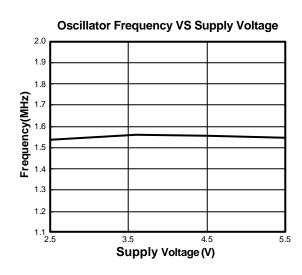


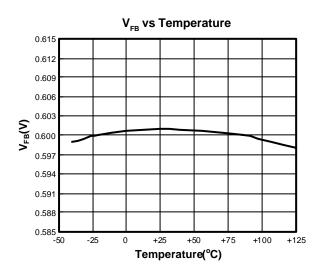


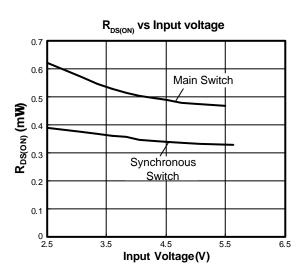


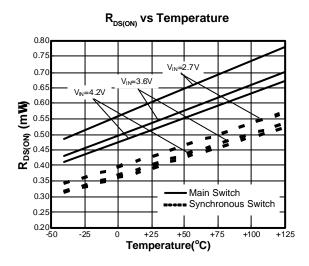


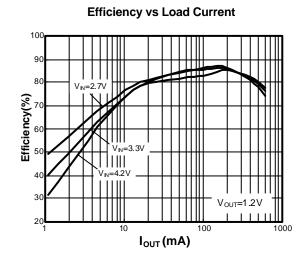






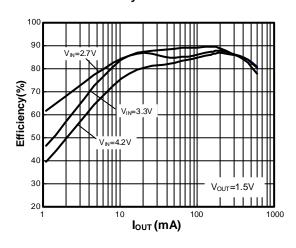




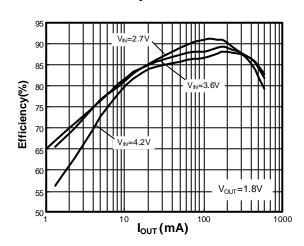




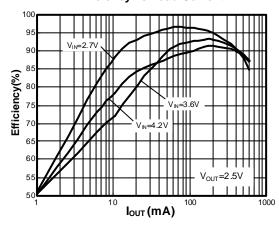
Efficiency vs Load Current



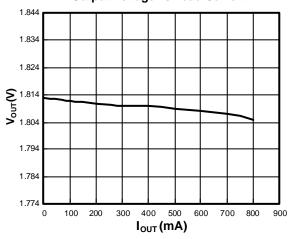
Efficiency vs Load Current



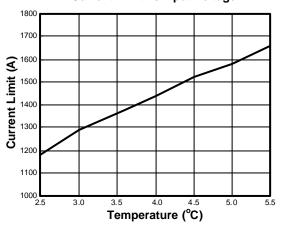
Efficiency vs Load Current



Output Voltage vs Load Current



Current Limit vs Input Voltage





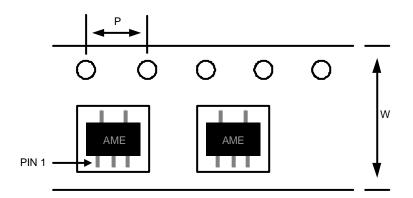
■ Date Code Rule

| Month Code | | | | |
|-------------|--------------|--|--|--|
| 1: January | 7: July | | | |
| 2: February | 8: August | | | |
| 3: March | 9: September | | | |
| 4: April | A: October | | | |
| 5: May | B: November | | | |
| 6: June | C: December | | | |

| | Year | | | | | |
|---|------|----------|----------|----------|----------|------|
| Α | Α | Α | М | Χ | Χ | xxx0 |
| Α | Α | Α | М | Χ | <u>X</u> | xxx1 |
| Α | Α | Α | М | <u>X</u> | Χ | xxx2 |
| Α | Α | Α | М | <u>X</u> | <u>X</u> | xxx3 |
| Α | Α | Α | <u>M</u> | Χ | Χ | xxx4 |
| Α | Α | Α | <u>M</u> | Χ | <u>X</u> | xxx5 |
| Α | Α | Α | <u>M</u> | <u>X</u> | Χ | xxx6 |
| Α | Α | Α | <u>M</u> | <u>X</u> | <u>X</u> | xxx7 |
| Α | Α | <u>A</u> | М | Χ | Χ | xxx8 |
| Α | Α | <u>A</u> | М | Χ | <u>X</u> | xxx9 |

■ Tape and Reel Dimension

SOT-25



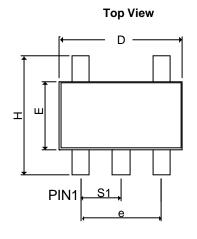
Carrier Tape, Number of Components Per Reel and Reel Size

| Package | Carrier Width (W) | Pitch (P) | Part Per Full Reel | Reel Size |
|---------|-------------------|------------|--------------------|-----------|
| SOT-25 | 8.0±0.1 mm | 4.0±0.1 mm | 3000pcs | 180±1 mm |



■ Package Dimension

SOT-25



Front View



Side View

| SYMBOLS | MILLIM | ETERS | INCHES | | |
|-----------------------|---------|-------|-------------|---------|--|
| STWIDOLS | MIN | MAX | MIN | MAX | |
| Α | 0.90 | 1.30 | 0.0354 | 0.0512 | |
| A ₁ | 0.00 | 0.15 | 0.0000 | 0.0059 | |
| b | 0.30 | 0.55 | 0.0118 | 0.0217 | |
| D | 2.70 | 3.10 | 0.1063 | 0.1220 | |
| E | 1.40 | 1.80 | 0.0551 | 0.0709 | |
| е | 1.90 | BSC | 0.07480 BSC | | |
| Н | 2.60 | 3.00 | 0.10236 | 0.11811 | |
| L | 0.37BSC | | 0.014 | 6BSC | |
| q 1 | 0° | 10° | 0° 10° | | |
| S ₁ | 0.95 | BSC | 0.037 | 4BSC | |



Life Support Policy:

These products of AME, Inc. are not authorized for use as critical components in life-support devices or systems, without the express written approval of the president of AME, Inc.

AME, Inc. reserves the right to make changes in the circuitry and specifications of its devices and advises its customers to obtain the latest version of relevant information.

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